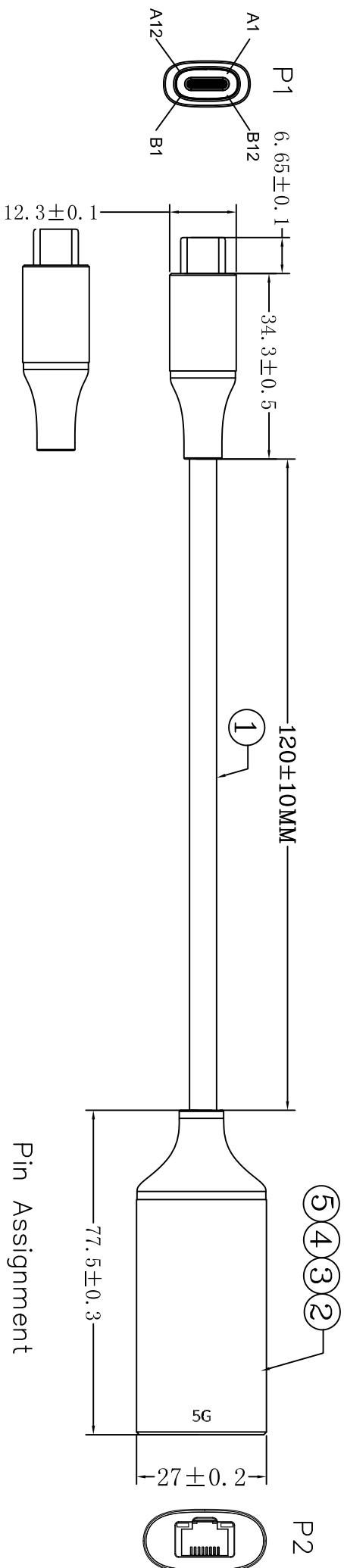
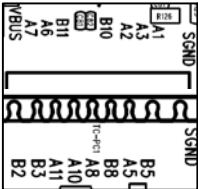


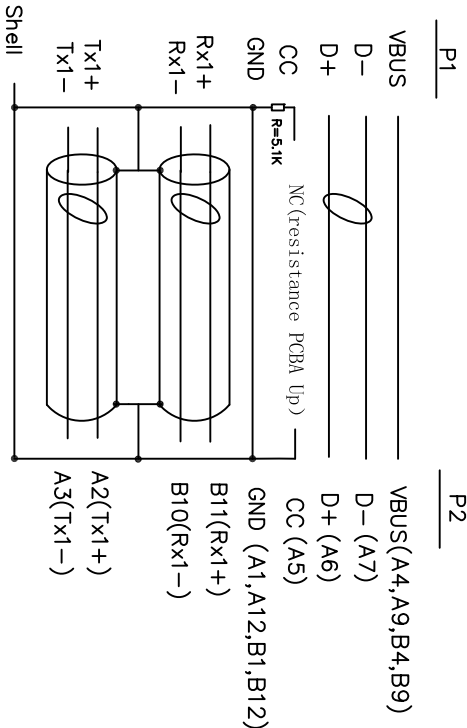


Mold comparison table:

Inner Molding: SRN5315-D-2-01-CE
TPE Outer Molding: SRW5315-D-2-01-CE



PCB Bonding pad



			TOLERANCE		ELECTRONICS TECHNOLOGY	
			INCHES	M/M	TITLE:	
			.X	.015	.30	UTC-5GE-FAL
			.XX	.010	.10	
			.XXX	.005	.05	
			DRAWN BY		CUSTOMER:	
			CHECK BY		CUSTOMER P/N:	
			APPD BY		SCALE	
					UNIT	
					DATE	
					DRAWING NO.:	
					REV.	
					1/2	

5	TPE 65P`Black	15	g
4	Plastic boffle`IN-2S-2782`PC-ABS`Gray	1	pcs
3	UTC-5GE-FAL Aluminum case`Aluminum Frame cavity`IN-CY-1545`Gray	1	pcs
2	UTC-5GE-FAL~PCB+SMT	1	pcs
1	USB3.2 Type-C Cable~C Male TO C Male ~OD:3.9MM~Black`TPE~L=0.40M~Nickel plating	1/2	pcs
NO	CELINK P/N	QTY	UNIT

DESCRIPTION		DATE	2024.7.16	H532300000064	1/2
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NO	CELINK P/N	DESCRIPTION	Q'TY	UNIT
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Space gray aluminum shell, printing
radium carving body dark gray

5G

3x2mm
图标居中端口
边距2.0mm

	TOLERANCE		SECOMP ELECTRONICS TECHNOLOGY				
	INCHES M/M						
	.X	.015					.30
	.XX	.010					.10
	.XXX	.005	.05	TITLE: U7C-5GE-PAL			
DRAWN BY			CUSTOMER :				
CHECK BY			CUSTOMER P/N :		RCL		
			SCALE		NONE		
APPD BY			UNIT		mm		
			DATE		2024.7.16		
			DRAWING NO.:		H5323000000064		
			REV.		A0		
					2/2		

